


- NOTES:
- MATERIAL:
HOUSING:LCP, BLACK, UL 94V-0
CONTACT:PHOSPHORBRONZE, T=0.10MM
SHELL:STAINLESS STEEL T=0.15MM
 - FINISH
CONTACT: 50u" NI MIN PLATING OVER ALL
1u" AU ON THE CONTACT AREA AND SOLDER AREA
SHELL:SELECTIVE 1u" AU ON SOLDER AREA
50u" NI MIN. PLATING OVER ALL
 - ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
ALL DIMENSIONS MARKER (XX) MUST BE MEASURE BY FAI.
 - GP PASSED ACCORD WITH HRD-ROHS-219 STANDARD
 - RATED PARAMETERS OF CONNECTOR
4-1.Operating temperature: -40°C to 70°C
4-2.Rated Current: 0.5A
4-3.Rated Voltage: 30V DC Per Contact
 - ELECTRICAL MECHANICAL ENVIRONMENTAL
5-1.Dielectric withstanding Voltage : 500V AC 1min.
5-2. Insulation Resistance: 1000 MΩMin.
5-3.Normal Force: 100g Min. Per Pin
5-4.Durability: 1000 cycles
5-5.Heat Resistance: 20mΩ MAX.

SIM CARD PIN NO.	PIN NO.
SIM CARD P1	VCC
SIM CARD P2	RST
SIM CARD P3	CLK
SIM CARD P4	RESERVED
SIM CARD P5	GND
SIM CARD P6	VPP
SIM CARD P7	I/O
SIM CARD P8	RESERVED
S/W	DETECT SWLTH

				UNITS: mm	GENERAL TOLERANCE		DRAW:	PART NO: S82-0B09F15A (优化版)
				DATE: 03/06/2017	X. ±0.25	X' ±5.00'	CHECKED:	TITLE: MICRO SIM CARD成品H=1.50mm
				SCALE: 8 / 1	.XX ±0.10	.XX' ±1.00'	APPROVE:	DRAWING NO:
A		NEW	03/06/2017	SHEET: 1 / 1	MATERIAL:		 昆山捷皇电子精密科技有限公司 HONGRIDA ELECTRONIC TECHNOLOGY CO., LTD.	
REV.	ECN NO.	DESCRIPTION	DATE	REV. A	FINISH: SEE NOTE			